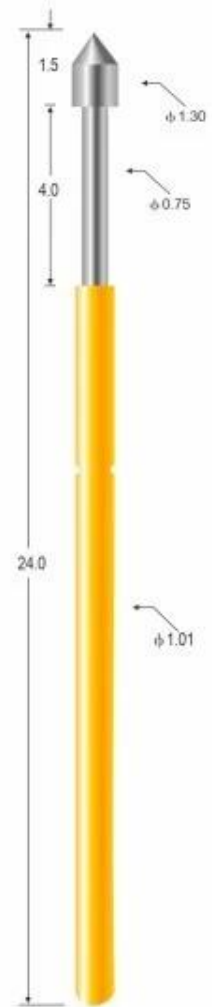


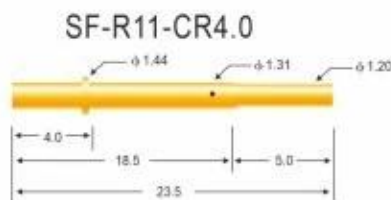
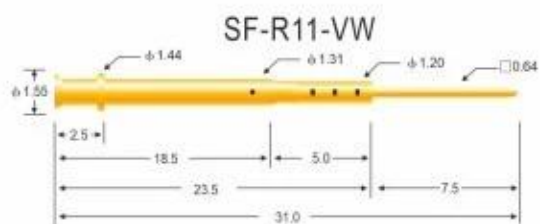
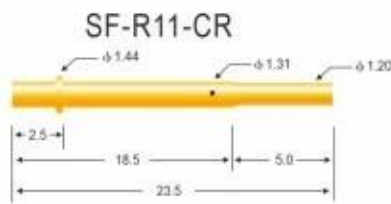
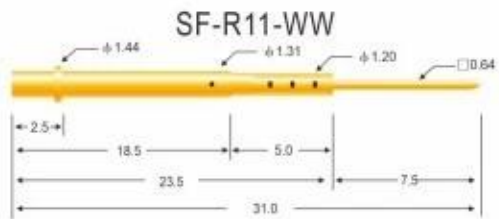
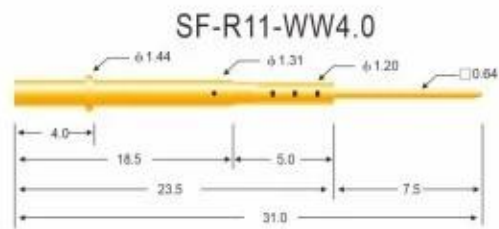
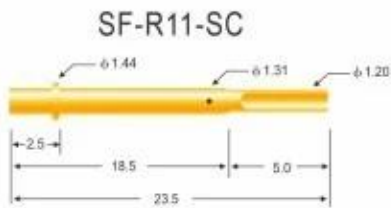
技术规格 PROBE SPECIFICATIONS

Recommended minimum center 最小间距	1.0mm(.0394 ")
Mounting hole size 钻孔尺寸	0.75mm(.0295 ")
Full travel 行程	2.0(.0787 ")
Spring force 弹簧压力	80g(克)
Materials and finishes 材料及涂饰	Plunger:SK4, Ni or Au plated BeCu, Ni or Au plated Phosphor bronze, Ni or Au plated Barrel:Phosphor bronze, Au plated Spring:Stainless steel
Current ration 额定电流	1A(安培)
Contact resistance 接触电阻	50mΩ(毫欧姆)

Receptacle specifications
Materials and finishes: Phosphor bronze,Gold plated



SP-P11-E



技术规格 PROBE SPECIFICATIONS

Recommended minimum center 最小间距	1.90mm(.0748 ")
Mounting hole size 钻孔尺寸	压克力: 1.35mm(.0532 ") 电木板、玻璃纤维板: 1.40mm(.0551 ")
Materials and finishes 材料及涂饰	Barrel: Brass, Au plated
Connections 接线形式	Crimp: R11-VCR, R11-CR, R11-CR4.0 Solder cup: R11-VSC, R11-SC, R11-SC4.0 Wire wrap: R11-VW, R11-WW, R11-WW4.0

Receptacle specifications
Materials and finishes: Phosphor bronze, Gold plated



1. 24-pin probe
2. OEM probe
3. Probe
4. Probe



1. PCB ICT FCT
2. 2
3. BGA
4. QZ VZ LM
- 5.
- 6.
7. 30# OK POM

I f



1. Raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection



5. Finished products



6. Packing





Q1. ــ

A1: ــ

Q2. ــ

A2: ــــــــــــــــــــــــ QC ــ 1 ــــــــــــــــــــــــ

Q3. ــ

A3: ــ

Q4. ــــــــــــــــ

A4: ــ

Q5. ــ

A5:

Q6.

A6:

Q7.OEM

A7: OEM/ODM

Q8.

A8: T/T/L/C MOQ L/C